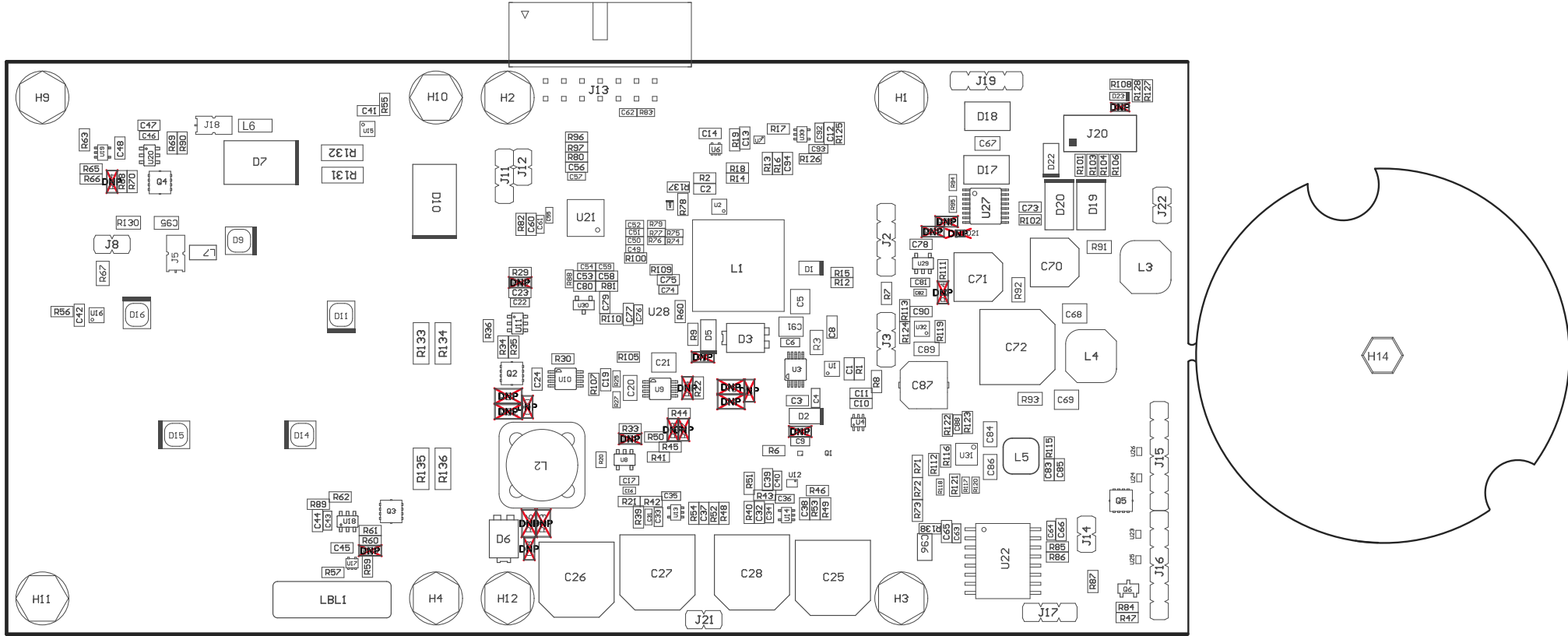


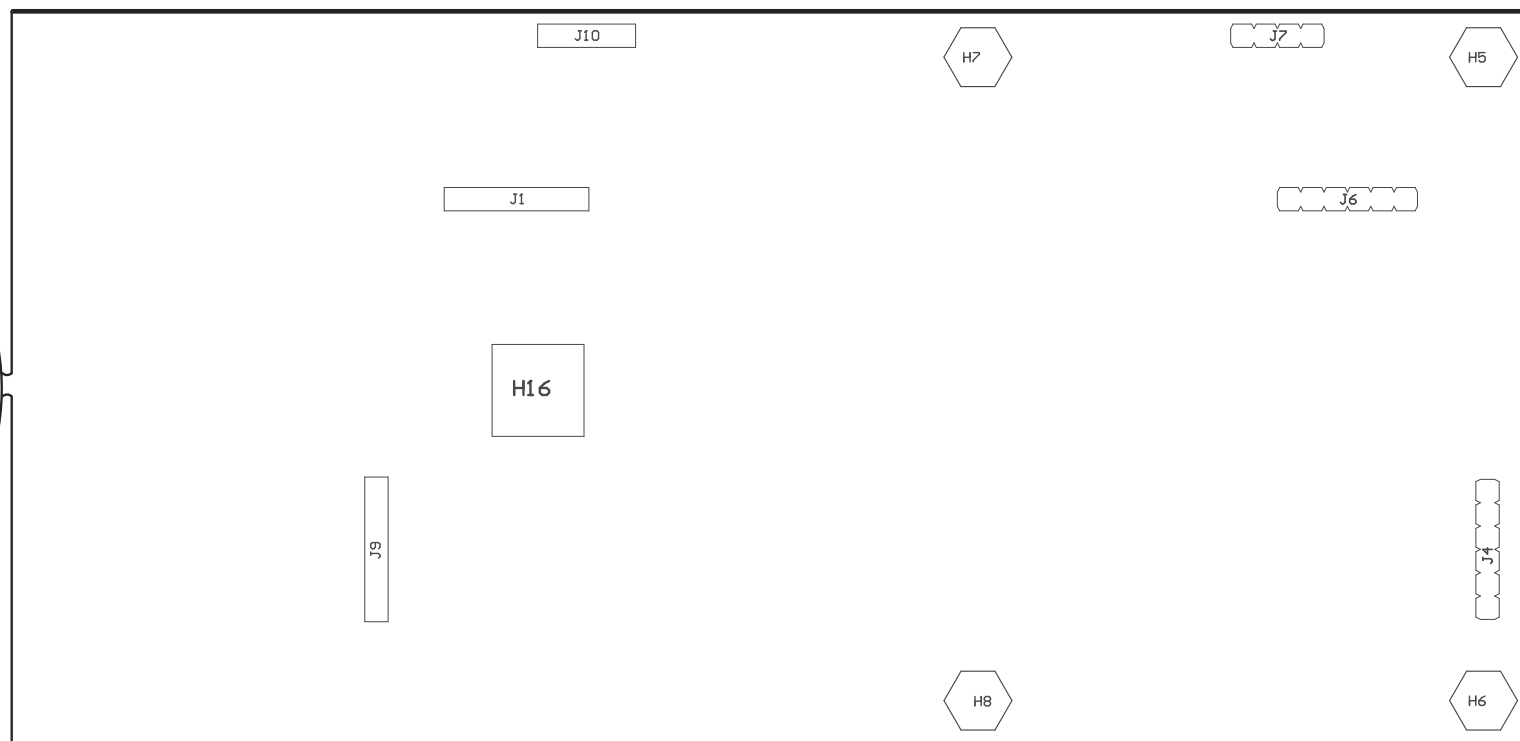
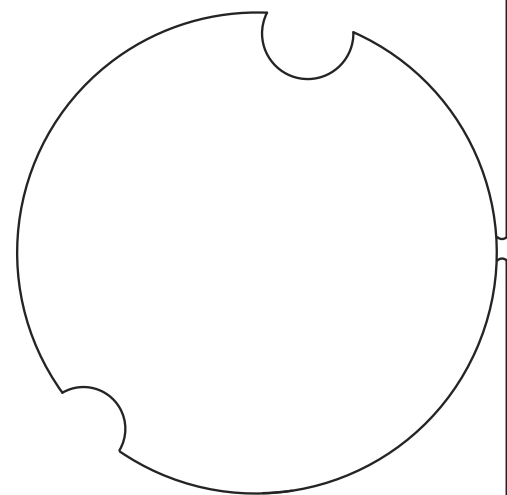
- ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

- ZZ5 ■ Place SH3 onto J3 Pin 1 - 2
- ZZ6 ■ Place SH5 onto J5 Pin 1 - 2
- ZZ7 ■ Place SH8 onto J8 Pin 1 - 2
- ZZ8 ■ Place SH11 onto J11 Pin 2 - 3
- ZZ9 ■ Place SH12 onto J12 Pin 1 - 2
- ZZ10 ■ Place SH17 onto J17 Pin 1 - 2
- ZZ11 ■ Place SH18 onto J18 Pin 1 - 2
- ZZ12 ■ Place SH20 onto J20 Pin 7 - 8
- ZZ13 ■ Place SH21 onto J21 Pin 1 - 2
- ZZ14 ■ Place SH22 onto J22 Pin 1 - 2



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01081	REV: E2	SUN REV: Not In VersionControl
	TID #: TIDA-01081		
PLOT NAME = Top Assembly Drawing	GENERATED : 12/12/2017 1:39:25 PM		TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01081	REV: E2	SUN REV: Not In VersionControl
	TID #: TIDA-01081		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/12/2017 1:39:27 PM		TEXAS INSTRUMENTS

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